Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
LED	Forward current		lF	25	mA
	Forward current derating (Ta ≥70°C)		IF / Ta	-0.8	mA / °C
	Pulse forward current	(Note 1)	IFP	50	mA
	Peak transient forward current	(Note 2)	IFPT	1	Α
	Reverse voltage		VR	(5)	V
	Diode power dissipation	(Note 3)	PD	45	mW
	Output current		10	8	mA
	Peak output current		lop	16	mA
ctor	Output voltage		Vo	-0.5 to 20	V
Detector	Supply voltage	_	Vcc	-0.5 to 30	V
	Output power dissipation		Po	100	mW
	Output power dissipation derating (Ta ≥70°C)		Po/Ta	-2	mW / °C
Operating temperature range			Topr	-55 to 100	ွင
Storage temperature range			T _{stg}	-55 to 125	 /ڥc
Lead solder temperature (10 s)		(Note 4)	T _{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %)		(Note 5)	BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50 % duty cycle, 1 ms pulse width. Derate 1.6 mA / °C above 70 °C.

(Note 2) Pulse width ≤ 1 µs, 300 pps.

(Note 3) Derate 0.9 mW / °C above 70 °C.

(Note 4) Soldering portion of lead: Up to 2 mm from the body of the device.

(Note 5) Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
LDE	Forward voltage	VF	I _F = 16 mA	_	1.65	1.85	V
	Forward voltage temperature coefficient	ΔV _F / ΔTa	IF = 16 mA	_	-2		mV /°C
	Reverse current	I _R	V _R = 5 V	/_	_	10	μΑ
	Capacitance between terminals	Ст	V = 0 V, f = 1 MHz		45		pF
Detector	High level output current	IOH (1)	IF = 0 mA, VCC = VO = 5.5 V		3	500	nA
		IOH (2)	IF = 0 mA, V _{CC} = 30 V, V _O = 20 V		_	5	
		Іон	$I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}, V_Q = 20 \text{ V}$ Ta = 70 °C	<u> </u>	_	50	μΑ
	High level supply voltage	Іссн	IF = 0 mA, VCC = 30 V	_	0.01	1	μΑ
	Current transfer ratio	I _O / I _F	IF = 16 mA, V _{CC} = 4.5 V V _O = 0.4 V	20	40		%
Coupled	Low level output voltage	VoL	IF = 16 mA, VCC = 4.5 V IO = 2.4 mA			0.4	V
	Resistance (input-output)	Rs	R.H.≤ 60 %, V _S = 500 V (Note 5)	1×10 ¹²	1014	_	Ω
	Capacitance (input-output)	Cs	$V_S = 0 V, f = 1 MHz$ (Note 5)		0.8	_	pF
	Isolation voltage	BVs	AC, 60 s (Note 5)	5000	_		Vrms

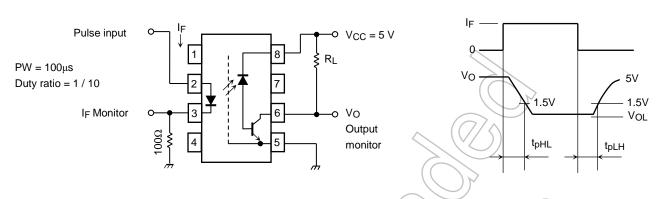
Switching Characteristics (Ta = 25°C, VCC = 5V)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Propagation delay time (H→ L)	tpHL		$I_F = 0 \rightarrow 16 \text{ mA},$ $R_L = 1.9 \text{ k}\Omega$	_	0.2	0.8	μS
Propagation delay time $(L \rightarrow H)$	tpLH		I _F = 16 \rightarrow 0 mA, RL = 1.9 kΩ	_	0.3	0.8	μS
Common mode transient immunity at logic high output (Note 1)	CMH	2	$I_F = 0 \text{ mA}, V_{CM} = 400 \text{ V}_{p-p}$ $R_L = 4.1 \text{ k}\Omega$	5000	10000	_	V / μs
Common mode transient immunity at logic low output (Note 1)	CML		IF = 16 mA, V _{CM} = 400 V _{p-p} R _L = 4.1 kΩ	-5000	-10000		V / μs

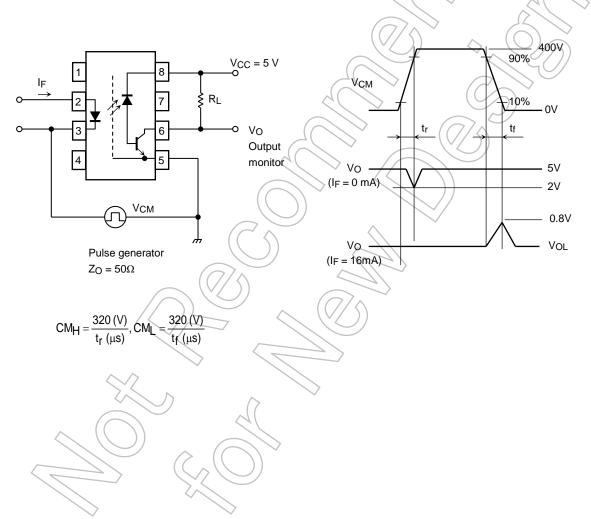
(Note 1) CM_L is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state (Vo < 0.8 V).

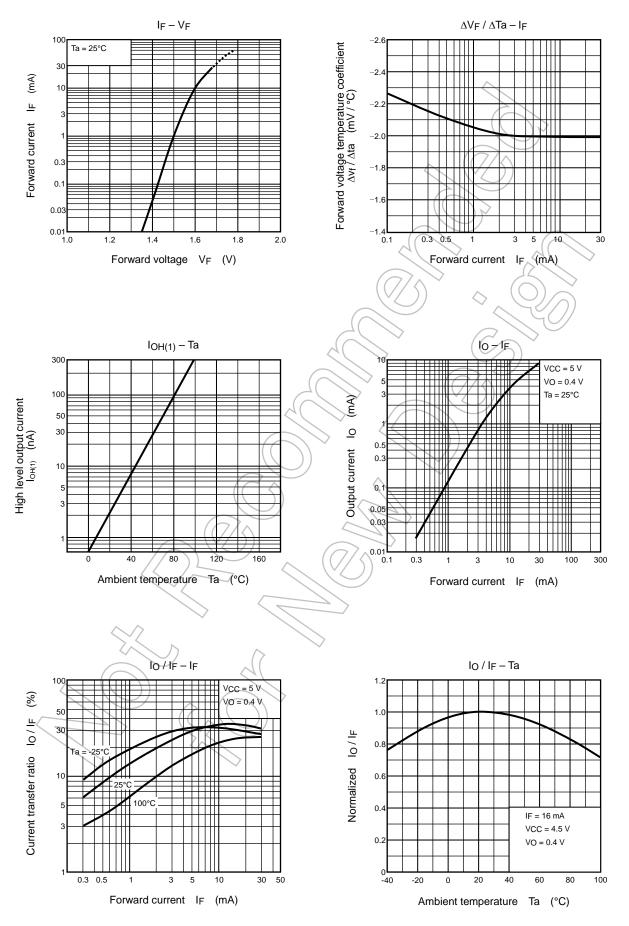
CMH is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ($V_0 > 2.0 \text{ V}$).

Test Circuit 1: Switching Time Test Circuit



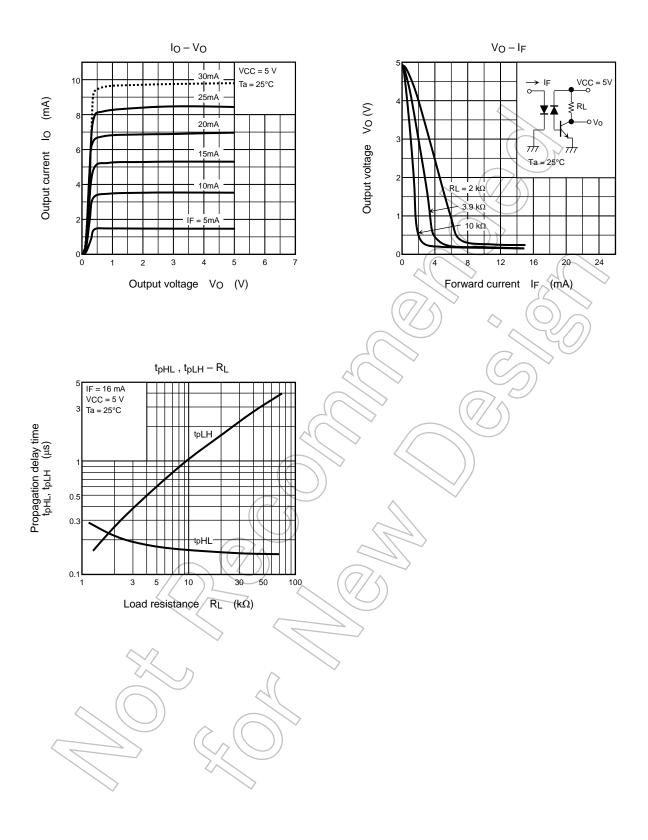






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